

September 1983 Revised February 1999

MM74HC240 Inverting Octal 3-STATE Buffer

General Description

The MM74HC240 3-STATE buffer utilizes advanced silicon-gate CMOS technology. It possesses high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits achieve speeds comparable to low power Schottky devices, while retaining the advantage of CMOS circuitry, i.e., high noise immunity and low power consumption. It has a fanout of 15 LS-TTL equivalent inputs.

The MM74HC240 is an inverting buffer and has two active LOW enables (1\overline{G} and 2\overline{G}). Each enable independently controls 4 buffers. The device has Schmitt trigger inputs.

All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

Features

- Typical propagation delay: 12 ns
- 3-STATE outputs for connection to system buses
- Wide power supply range: 2-6V
- Low quiescent supply current: 80 µA (74 Series)
- Output current: 6 mA

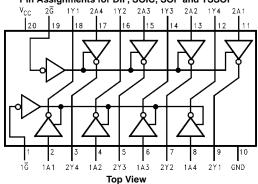
Ordering Code:

Order Number Package Number		Package Description				
MM74HC240WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide				
MM74HC240SJ M20D		20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide				
MM74HC240MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide				
MM74HC240N	N20A	20-Lead Plastic Dual-In-Package (PDIP), JEDEC MS-001, 0.300" Wide				

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP

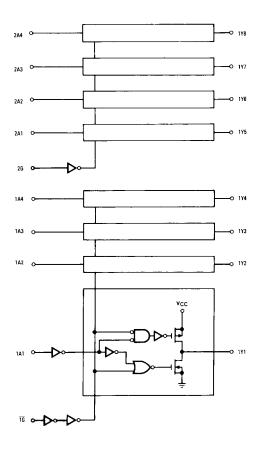


Truth Table

1G	1A	1Y	2G	2A	2Y
L	L	Н	L	L	Н
L	Н	L	L	Н	L
Н	L	Z	Н	L	Z
Н	Н	Z	Н	Н	Z

H = HIGH Level L = LOW Level Z = HIGH Impedance

Logic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

Supply Voltage (V _{CC})	-0.5 to +7.0V
DC Input Voltage (V _{IN})	-1.5 to V_{CC} +1.5V
DC Output Voltage (V _{OUT})	-0.5 to V_{CC} +0.5 V
Clamp Diode Current (I _{IK} , I _{OK})	±20 mA
DC Output Current, per pin (I _{OUT})	±35 mA
DC V_{CC} or GND Current, per pin (I_{CC})	±70 mA
Storage Temperature Range (T _{STG})	-65°C to +150°C
Power Dissipation (P _D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T _L)	
(Soldering 10 seconds)	260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T _A)	-40	+85	°C
Input Rise or Fall Times			
$(t_r, t_f) V_{CC} = 2.0V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: –
12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Parameter	Conditions	v _{cc}	$T_A = 25^{\circ}C$		$T_A = -40 \text{ to } 85^{\circ}\text{C}$	$T_A = -55 \text{ to } 125^{\circ}\text{C}$	Units	
	Conditions		Тур	Guaranteed L		imits	Ullits	
Minimum HIGH Level		2.0V		1.5	1.5	1.5	V	
Input Voltage		4.5V		3.15	3.15	3.15	V	
		6.0V		4.2	4.2	4.2	V	
Maximum LOW Level		2.0V		0.5	0.5	0.5	V	
Input Voltage		4.5V		1.35	1.35	1.35	V	
		6.0V		1.8	1.8	1.8	V	
Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}							
Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	2.0	1.9	1.9	1.9	V	
		4.5V	4.5	4.4	4.4	4.4	V	
		6.0V	6.0	5.9	5.9	5.9	V	
	$V_{IN} = V_{IH}$ or V_{IL}							
	$ I_{OUT} \le 6.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V	
	$ I_{OUT} \le 7.8 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V	
Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}							
Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	0	0.1	0.1	0.1	V	
		4.5V	0	0.1	0.1	0.1	V	
		6.0V	0	0.1	0.1	0.1	V	
	$V_{IN} = V_{IH}$ or V_{IL}							
	$ I_{OUT} \le 6.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V	
	$ I_{OUT} \le 7.8 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V	
Maximum Input	V _{IN} = V _{CC} or GND	6.0V		±0.1	±1.0	±1.0	μΑ	
Current								
Maximum 3-STATE	$V_{IN} = V_{IH}$ or V_{IL}	6.0V		±0.5	±5	±10	μΑ	
Output Leakage	$V_{OUT} = V_{CC}$ or GND							
Current	$\overline{G} = V_{IH}, G = V_{IL}$							
Maximum Quiescent	V _{IN} = V _{CC} or GND	6.0V		8.0	80	160	μΑ	
Supply Current	$I_{OUT} = 0 \mu A$							
	Minimum HIGH Level Input Voltage Maximum LOW Level Input Voltage Minimum HIGH Level Output Voltage Maximum LOW Level Output Voltage Maximum Input Current Maximum 3-STATE Output Leakage Current Maximum Quiescent	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c} \text{Minimum HIGH Level} \\ \text{Input Voltage} \\ \end{array} \begin{array}{c} 2.0V \\ 4.5V \\ 6.0V \\ \end{array} \\ \text{Maximum LOW Level} \\ \text{Input Voltage} \\ \end{array} \begin{array}{c} 2.0V \\ 4.5V \\ 6.0V \\ \end{array} \\ \text{Minimum HIGH Level} \\ \text{Output Voltage} \\ \end{array} \begin{array}{c} V_{I \text{ N}} = V_{IH} \text{ or } V_{IL} \\ I_{OUT} \leq 20 \ \mu\text{A} \\ I_{OUT} \leq 20 \ \mu\text{A} \\ \end{array} \begin{array}{c} 2.0V \\ 4.5V \\ 6.0V \\ \end{array} \\ \begin{array}{c} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OUT} \leq 6.0 \text{ mA} \\ I_{OUT} \leq 7.8 \text{ mA} \\ \end{array} \begin{array}{c} 6.0V \\ \end{array} \\ \text{Maximum LOW Level} \\ \text{Output Voltage} \\ \end{array} \begin{array}{c} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OUT} \leq 20 \ \mu\text{A} \\ \end{array} \begin{array}{c} 2.0V \\ 4.5V \\ 6.0V \\ \end{array} \\ \begin{array}{c} 4.5V \\ 6.0V \\ \end{array} \\ \begin{array}{c} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OUT} \leq 6.0 \text{ mA} \\ I_{OUT} \leq 7.8 \text{ mA} \\ \end{array} \begin{array}{c} 6.0V \\ \end{array} \\ \begin{array}{c} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OUT} \leq 7.8 \text{ mA} \\ \end{array} \begin{array}{c} 6.0V \\ \end{array} \\ \begin{array}{c} V_{IN} = V_{IH} \text{ or } V_{IL} \\ \end{array} \\ \begin{array}{c} 0.0V \\ \end{array} \\ \begin{array}{c} V_{IN} = V_{IH} \text{ or } V_{IL} \\ \end{array} \begin{array}{c} 0.0V \\ \end{array} \\ \begin{array}{c} 0.0V \\ \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Minimum HIGH Level 1.5	Parameter Conditions V _{CC} Typ Guaranteed L	Parameter Conditions V _{CC} Typ Guaranteed Limits	

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{O2}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $t_r = t_f = 6$ ns

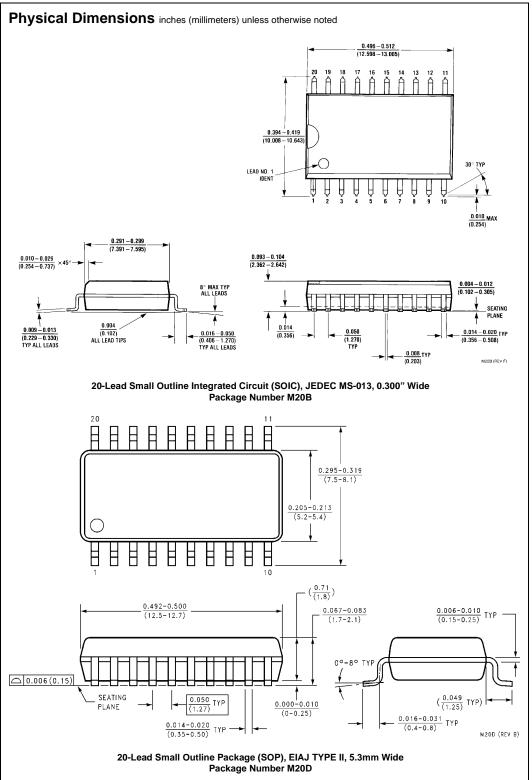
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Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units	
t _{PHL} , t _{PLH}	Maximum Propagation Delay	C _L = 45 pF	12	18	ns	
t _{PZH} , t _{PZL}	Maximum Enable Delay	$R_L = 1 \text{ k}\Omega$	14	28	ns	
	to Active Output	$C_L = 45 pF$				
t _{PHZ} , t _{PLZ}	Maximum Disable Delay	$R_L = 1 k\Omega$	13	25	ns	
	from Active Output	$C_L = 5 pF$				

AC Electrical Characteristics

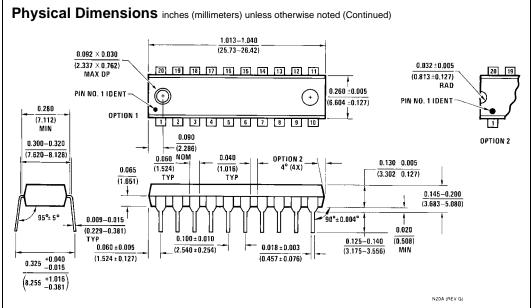
 $V_{CC} = 2.0 \, \text{V}$ to 6.0V, $C_L = 50$ pF, $t_{\text{r}} = t_{\text{f}} = 6$ ns (unless otherwise specified)

Symbol	Parameter	Conditions	v _{cc}	$T_A = 25^{\circ}C$		T _A = -40 to 85°C	$T_A = -55$ to $125^{\circ}C$	Units	
Cynnbon	i diametei			Тур		Guaranteed L	Onito		
t_{PHL},t_{PLH}	Maximum Propagation	C _L = 50 pF	2.0V	55	100	126	149	ns	
	Delay	C _L = 150 pF	2.0V	80	150	190	224	ns	
		C _L = 50 pF	4.5V	12	20	25	30	ns	
		C _L = 150 pF	4.5V	22	30	38	45	ns	
		C _L = 50 pF	6.0V	11	17	21	25	ns	
		C _L = 150 pF	6.0V	28	26	32	38	ns	
t_{PZH},t_{PZL}	Maximum Output Enable	$R_L = 1 k\Omega$							
	TIme	$C_L = 50 pF$	2.0V	75	150	189	224	ns	
		C _L = 150 pF	2.0V	100	200	252	298	ns	
		C _L = 50 pF	4.5V	15	30	38	45	ns	
		C _L = 150 pF	4.5V	20	40	50	60	ns	
		C _L = 50 pF	6.0V	13	26	32	38	ns	
		C _L = 150 pF	6.0V	17	34	43	51	ns	
t_{PHZ},t_{PLZ}	Maximum Output Disable	$R_L = 1 k\Omega$	2.0V	75	150	189	224	ns	
	Time	$C_L = 50 pF$	4.5V	15	30	38	45	ns	
			6.0V	13	26	32	38	ns	
t_{TLH} , t_{THL}	Maximum Output		2.0V		60	75	90	ns	
	Rise and Fall Time		4.5V		12	15	18	ns	
			6.0V		10	13	15	ns	
C _{PD}	Power Dissipation	(per buffer)							
	Capacitance (Note 5)	$\overline{G} = V_{IH}$		12				pF	
		$\overline{G} = V_{IL}$		50				pF	
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF	
C _{OUT}	Maximum Output Capacitance			10	20	20	20	pF	

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) -0.20 و2ا 7.72 4.16 6,4 4.4±0.1 -B-3,2 10.42 PIN #1 IDENT. LAND PATTERN RECOMMENDATION O.1 C SEE DETAIL A -0.90+0.15 0.09-0.20 0.1±0.05 0.65 0.19-0.30 | \$\P\$ | 0.10\P\$ | A| P\$ | C\$ | -12.00° R0.09min GAGE PLANE DIMENSIONS ARE IN MILLIMETERS NOTES: 0.25 SEATING PLANE A. CONFORMS TO JEDEC REGISTRATION MID-153, VARIATION AC, REF NOTE 6, DATE $7/93.\,$ -0.6±0.1-R0.09mln -1.00 B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS. DETAIL A D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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